

Vishay Siliconix

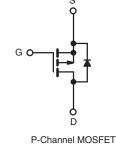
RoHS

COMPLIANT

Power MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	- 100			
R _{DS(on)} (Ω)	V _{GS} = - 10 V 1.2			
Q _g (Max.) (nC)	8.7			
Q _{gs} (nC)	2.2			
Q _{gd} (nC)	4.1			
Configuration	Single			





FEATURES

- Dynamic dV/dt Rating
- Repetitive Avalanche Rated
- For Automatic Insertion
- End Stackable
- P-Channel
- 175 °C Operating Temperature
- Fast Switching
- Compliant to RoHS Directive 2002/95/EC

DESCRIPTION

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The 4 pin DIP package is a low cost machine-insertable case style which can be stacked in multiple combinations on standard 0.1" pin centers. The dual drain serves as a thermal link to the mounting surface for power dissipation levels up to 1 W.

ORDERING INFORMATION		
Package	HVMDIP	
Lead (Pb)-free	IRFD9110PbF	
	SiHFD9110-E3	
SnPb	IRFD9110	
	SiHFD9110	

ABSOLUTE MAXIMUM RATINGS (T _A	= 25 °C, unless otherwis	se noted)			
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-Source Voltage		V _{DS}	- 100	v	
Gate-Source Voltage		V _{GS}	± 20	v	
Continuous Drain Current	V_{GS} at - 10 V $T_A = 25 \degree C$	1	- 0.70		
Continuous Drain Current	V_{GS} at - 10 V $T_A = 25 °C$ $T_A = 100 °C$	ID	- 0.49	А	
Pulsed Drain Current ^a	I _{DM}	- 5.6			
Linear Derating Factor		0.0083	W/°C		
Single Pulse Avalanche Energy ^b		E _{AS}	140	mJ	
Repetitive Avalanche Current ^a		I _{AR}	- 0.7	А	
Repetitive Avalanche Energy ^a		E _{AR}	0.13	mJ	
Maximum Power Dissipation	T _A = 25 °C	PD	1.3	W	
Peak Diode Recovery dV/dt ^c	dV/dt	- 5.5	V/ns		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to + 175		
Soldering Recommendations (Peak Temperature) for 10 s			300 ^d	- °C	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. $V_{DD} = -25 \text{ V}$, starting $T_J = 25 \text{ °C}$, L = 52 mH, $R_g = 25 \Omega$, $I_{AS} = -2.0 \text{ A}$ (see fig. 12).

c. $I_{SD} \leq$ - 4.0 A, dl/dt \leq 75 A/µs, $V_{DD} \leq V_{DS}$, $T_J \leq$ 175 °C.

d. 1.6 mm from case.

* Pb containing terminations are not RoHS compliant, exemptions may apply

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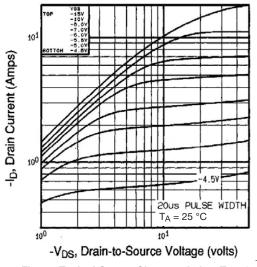
PARAMETER	SYMBOL	TYP.		MAX.			UNIT	
Maximum Junction-to-Ambient	R _{thJA}	-		120			°C/W	
SPECIFICATIONS (T _J = 25 $^{\circ}$ C, u	nless otherw	ise noted)						
PARAMETER	SYMBOL	TES		DNS	MIN.	TYP.	MAX.	UNIT
Static								
Drain-Source Breakdown Voltage	V_{DS}	V _{GS} =	= 0 V, I _D = - 2	250 μA	- 100	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_J$	Reference	e to 25 °C, I _D	= - 1 mA	-	- 0.091	-	V/°C
Gate-Source Threshold Voltage	V _{GS(th)}	-	$V_{GS}, I_D = -2$		- 2.0	-	- 4.0	V
Gate-Source Leakage	I _{GSS}		$V_{GS} = \pm 20$ \		-	-	± 100	nA
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =	- 100 V, V _G	_S = 0 V	-	-	- 100	μA
Zero date voltage Brain ourient	'D88	V _{DS} = - 80 V	V, V _{GS} = 0 V,	T _J = 150 °C	-	-	- 500	μ, τ
Drain-Source On-State Resistance	R _{DS(on)}	V_{GS} = - 10 V	I _D =	- 0.42 A ^b	-	-	1.2	Ω
Forward Transconductance	g fs	V _{DS} =	- 50 V, I _D = -	0.42 A	0.60	-	-	S
Dynamic								
Input Capacitance	C _{iss}		$V_{GS} = 0 V,$		-	200	-	
Output Capacitance	Coss		V _{DS} = - 25 V,		-	94	-	pF
Reverse Transfer Capacitance	C _{rss}	f = 1	.0 MHz, see	0 MHz, see fig. 5		18	-	
Total Gate Charge	Qg		$I_{\rm D} = -4.0 \text{ A}, V_{\rm DS} = -80 \text{ V}$ see fig. 6 and 13 ^b -		-	-	8.7	
Gate-Source Charge	Q _{gs}	V _{GS} = - 10 V			-	2.2	nC	
Gate-Drain Charge	Q _{gd}				-	-	4.1	1
Turn-On Delay Time	t _{d(on)}		50.14.1		-	10	-	
Rise Time	t _r				-	27	-	
Turn-Off Delay Time	t _{d(off)}	$\begin{tabular}{ c c c c c c c c c c c c c c c c c c c$		15	-	- ns		
Fall Time	t _f			17	-			
Internal Drain Inductance	L _D	Between lead, 6 mm (0.25") from package and center of die contact - 4.0 - 4.0 - 6.0		-	- nH			
Internal Source Inductance	L _S			6.0	-			
Drain-Source Body Diode Characteristic	S							
Continuous Source-Drain Diode Current	I _S	MOSFET sym showing the			-	-	- 0.70	A
Pulsed Diode Forward Current ^a	I _{SM}	integral reverse p - n junction diode		-	-	- 5.6		
Body Diode Voltage	V_{SD}	$T_{J} = 25 \ ^{\circ}C, \ I_{S} = - \ 0.7 \ A, \ V_{GS} = 0 \ V^{b}$		-	-	- 5.5	V	
Body Diode Reverse Recovery Time	t _{rr}	- T _J = 25 °C, I _F = - 4.0 A, dl/dt = 100 A/μs ^b		-	82	160	ns	
Body Diode Reverse Recovery Charge	Q _{rr}			-	0.15	0.30	μC	

Notes

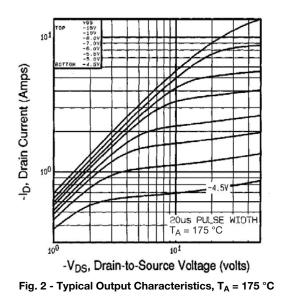
a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11). b. Pulse width \leq 300 µs; duty cycle \leq 2 %.

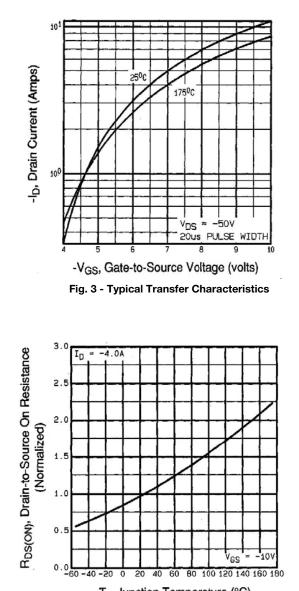












T_J, Junction Temperature (°C) Fig. 4 - Normalized On-Resistance vs. Temperature



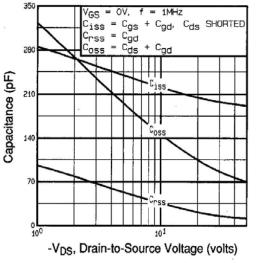
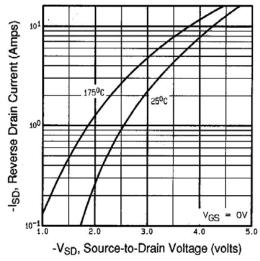


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage





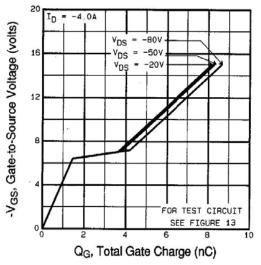
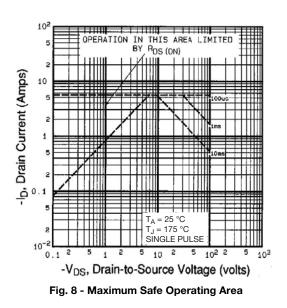


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage





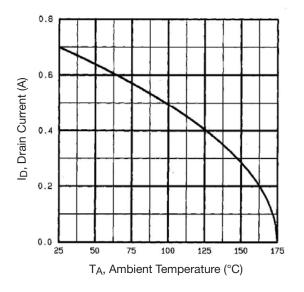


Fig. 9 - Maximum Drain Current vs. Ambient Temperature

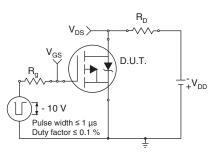


Fig. 10a - Switching Time Test Circuit

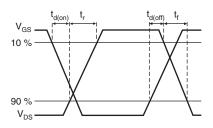


Fig. 10b - Switching Time Waveforms

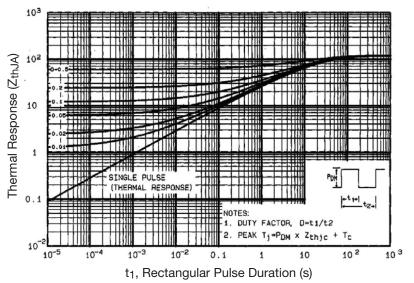


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Ambient



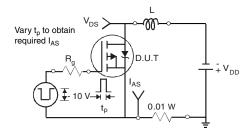


Fig. 12a - Unclamped Inductive Test Circuit

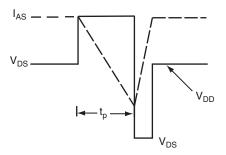


Fig. 12b - Unclamped Inductive Waveforms

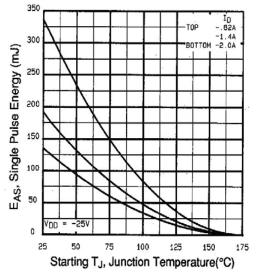


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

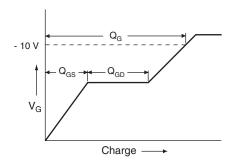


Fig. 13a - Basic Gate Charge Waveform

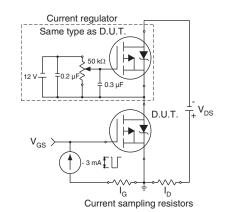
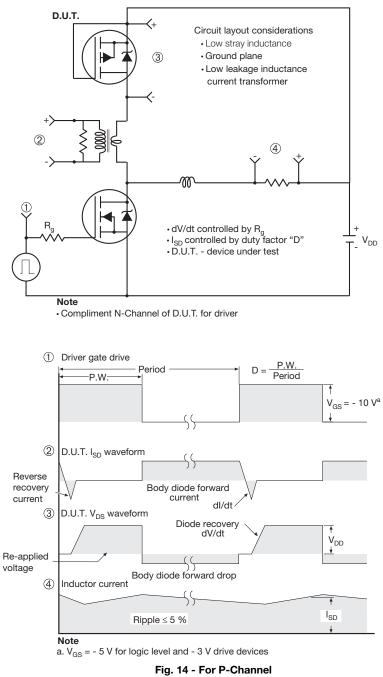


Fig. 13b - Gate Charge Test Circuit



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Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?91138.



Vishay Siliconix

HVM DIP (High voltage)





	INCHES		MILLIN	IETERS
DIM.	MIN.	MAX.	MIN.	MAX.
А	0.310	0.330	7.87	8.38
E	0.300	0.425	7.62	10.79
L	0.270	0.290	6.86	7.36
ECN: X10-0386-Rev. B, 0 DWG: 5974	06-Sep-10			

Note

1. Package length does not include mold flash, protrusions or gate burrs. Package width does not include interlead flash or protrusions.



Vishay

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